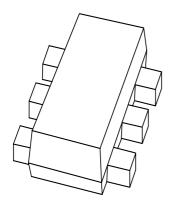
DISCRETE SEMICONDUCTORS

DATA SHEET



BC847BV NPN general purpose double transistor

Product specification

2001 Sep 10





NPN general purpose double transistor

BC847BV

FEATURES

- 300 mW total power dissipation
- Very small 1.6 mm \times 1.2 mm \times 0.55 mm ultra thin package
- · Excellent coplanarity due to straight leads
- · Low collector capacitance
- Improved thermal behaviour due to flat leads
- Reduces number of components as replacement of two SC-75/SC-89 packaged BISS transistors
- · Reduces required board space
- · Reduces pick and place costs.

APPLICATIONS

• General purpose switching and amplification.

DESCRIPTION

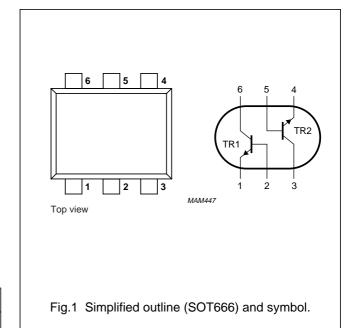
NPN double transistor in a SOT666 plastic package. PNP complement: BC857BV.

MARKING

TYPE NUMBER	MARKING CODE
BC847BV	1F

PINNING

PIN	DESCRIPTION		
1, 4	emitter	TR1; TR2	
2, 5	base	TR1; TR2	
6, 3	collector	TR1; TR2	



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LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT		
Per transis	Per transistor						
V _{CBO}	collector-base voltage	open emitter	_	50	V		
V _{CEO}	collector-emitter voltage	open base	_	45	V		
V _{EBO}	emitter-base voltage	open collector	_	5	V		
I _C	collector current (DC)		-	100	mA		
I _{CM}	peak collector current		_	200	mA		
I _{BM}	peak base current		_	200	mA		
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C; note 1	-	200	mW		
T _{stg}	storage temperature		-65	+150	°C		
Tj	junction temperature		_	150	°C		
T _{amb}	operating ambient temperature		-65	+150	°C		
Per device	Per device						
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C; note 1	-	300	mW		

Note

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R _{th j-a}	thermal resistance from junction to ambient	notes 1 and 2	416	K/W

Notes

- 1. Transistor mounted on an FR4 printed-circuit board.
- 2. The only recommended soldering method is reflow soldering.

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^{1.} Transistor mounted on an FR4 printed-circuit board.

NPN general purpose double transistor

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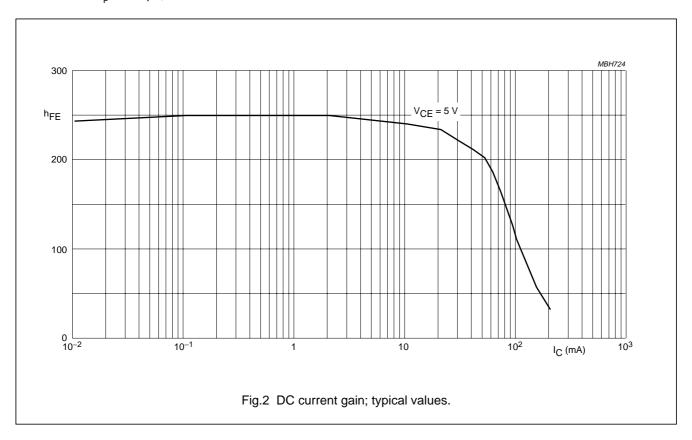
CHARACTERISTICS

 T_{amb} = 25 °C; unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
Per transistor						
I _{CBO}	collector-base cut-off current	I _E = 0; V _{CB} = 30 V	_	_	15	nA
		I _E = 0; V _{CB} = 30 V; T _j = 150 °C	_	_	5	μΑ
I _{EBO}	emitter-base cut-off current	$I_C = 0; V_{EB} = 5 V$	_	_	100	nA
h _{FE}	DC current gain	$I_C = 2 \text{ mA}; V_{CE} = 5 \text{ V}$	200	_	450	
V_{BE}	base-emitter voltage	$I_C = 2 \text{ mA}; V_{CE} = 5 \text{ V}$	580	655	700	mV
V _{CEsat}	collector-emitter saturation voltage	$I_C = 10 \text{ mA}; I_B = 0.5 \text{ mA}$	_	_	100	mV
		$I_C = 100 \text{ mA}$; $I_B = 5 \text{ mA}$; note 1	_	_	300	mV
V _{BEsat}	base-emitter saturation voltage	$I_C = 10 \text{ mA}; I_B = 0.5 \text{ mA}$	_	755	-	mV
C _c	collector capacitance	$I_E = I_e = 0$; $V_{CB} = 10 \text{ V}$; $f = 1 \text{ MHz}$	_	_	1.5	pF
C _e	emitter capacitance	$I_C = i_c = 0$; $V_{EB} = 500 \text{ mV}$; $f = 1 \text{ MHz}$	_	11	_	pF
f _T	transition frequency	$I_C = 10 \text{ mA}; V_{CE} = 5 \text{ V}; f = 100 \text{ MHz}$	100	_	_	MHz

Note

1. Pulse test: $t_p \le 300~\mu s;~\delta \le 0.02.$

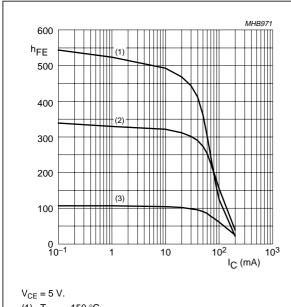


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NPN general purpose double transistor

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Graphical information BC847BV

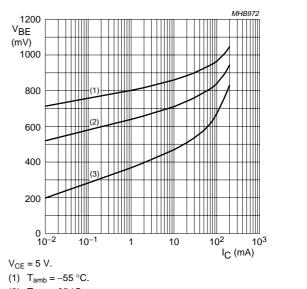


(1) $T_{amb} = 150 \, ^{\circ}C$.

(2) $T_{amb} = 25 \, ^{\circ}C$.

(3) $T_{amb} = -55 \, ^{\circ}C$.

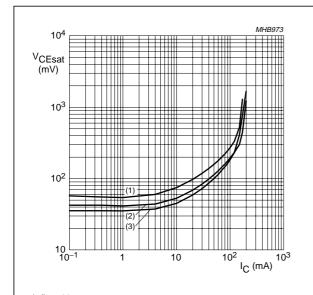
Fig.3 DC current gain; typical values.



(2) $T_{amb} = 25 \, ^{\circ}C$.

(3) $T_{amb} = 150 \, ^{\circ}C$.

Fig.4 Base-emitter voltage as a function of collector current; typical values.



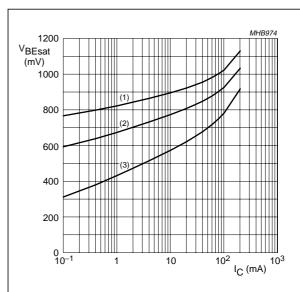
 $I_{\rm C}/I_{\rm B}=20.$

(1) $T_{amb} = 150 \, ^{\circ}C$.

(2) $T_{amb} = 25 \, ^{\circ}C$.

(3) $T_{amb} = -55 \, ^{\circ}C$.

Fig.5 Collector-emitter saturation voltage as a function of collector current; typical values.



I_C/I_B 20.

(1) $T_{amb} = -55 \, ^{\circ}C$.

(2) $T_{amb} = 25 \,^{\circ}C$.

(3) $T_{amb} = 150 \, ^{\circ}C$.

Fig.6 Base-emitter saturation voltage as a function of collector current; typical values.

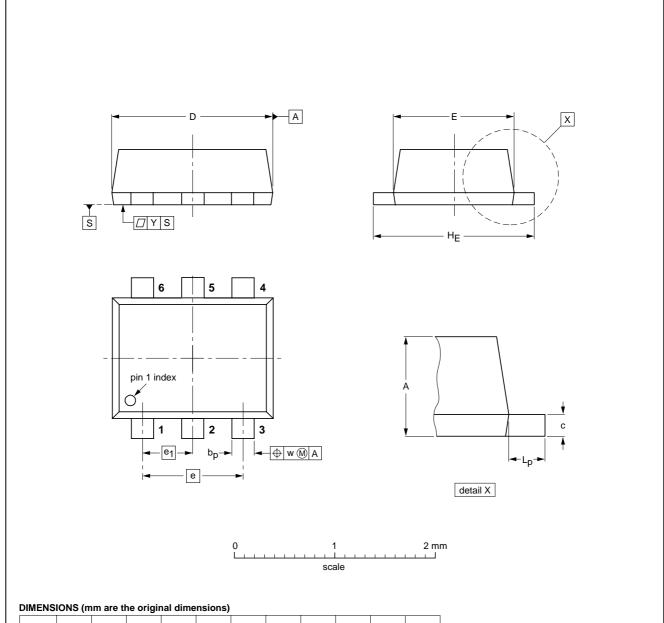
NPN general purpose double transistor

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PACKAGE OUTLINE

Plastic surface mounted package; 6 leads

SOT666



UNIT	A	bp	С	D	E	е	e ₁	HE	L _p	w	у
mm	0.6 0.5	0.27 0.17	0.18 0.08	1.7 1.5	1.3 1.1	1.0	0.5	1.7 1.5	0.3 0.1	0.1	0.1

OUTLINE	REFERENCES				EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE
SOT666						-01-01-04 01-08-27

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NPN general purpose double transistor

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DATA SHEET STATUS(1)	PRODUCT STATUS ⁽²⁾	DEFINITIONS
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